

### **MOSFET**

### OptiMOS™ 5 Power-Transistor, 150 V

### **Features**

- N-channel
- Very low on-resistance R<sub>DS(on)</sub>
   Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

### **Product validation**

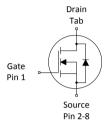
Fully qualified according to JEDEC for Industrial Applications

**Key Performance Parameters** Table 1

Parameter	Value	Unit					
$V_{ m DS}$	150	V					
$R_{\mathrm{DS(on),max}}$	3.9	mΩ					
I <sub>D</sub>	190	A					
$Q_{ m oss}$	219	nC					
$Q_{G}$	78	nC					











Type/Ordering Code	Package	Marking	Related Links
IPT039N15N5	PG-HSOF-8	039N15N5	-

### Public

# OptiMOS™ 5 Power-Transistor, 150 V IPT039N15N5



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# OptiMOS™ 5 Power-Transistor, 150 V IPT039N15N5



## 1 Maximum ratings

unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Nato/Task Condition
ratattietei	Syllibot	Min.	Тур.	Мах.		Note/ Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	190 134 128 21	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =40°C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	760	А	T <sub>A</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	255	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	$V_{GS}$	-20	-	20	V	-
Power dissipation	$P_{tot}$	-	-	319 3.8	w	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W <sup>2)</sup>
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-55	-	175	°C	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

### 2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Symbol	Values			l lnit	Nieto/Tost Condition	
Parameter		Min.	Тур.	Мах.	Unit	Note/ Test Condition	
Thermal resistance, junction - case	$R_{\mathrm{thJC}}$	-	-	0.47	°C/W	-	
Thermal resistance, junction - ambient, minimal footprint	$R_{ m thJA}$	-	-	62	°C/W	-	
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>5)</sup>	$R_{thJA}$	-	-	40	°C/W	-	

<sup>&</sup>lt;sup>5)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

<sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS™ 5 Power-Transistor, 150 V IPT039N15N5



## 3 Electrical characteristics

unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Symbol	Min.	Тур.	Мах.	Oilit	Note/ Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	150	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.8	4.6	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 257 \mu{\rm A}$	
Zero gate voltage drain current	$I_{\mathrm{DSS}}$	-	0.1 10	1.0 100	μΑ	$V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	3.3 3.6	3.9 4.3	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A $V_{\rm GS}$ =8 V, $I_{\rm D}$ =25 A	
Gate resistance <sup>6)</sup>	$R_{G}$	-	1.1	1.6	Ω	-	
Transconductance	$g_{fs}$	-	110	-	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 50 \text{ A}$	

<sup>6)</sup> Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Darameter	Symbol	Values			Unit	Note/Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/ Test Condition	
Input capacitance <sup>7)</sup>	C <sub>iss</sub>	-	5900	7700	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =75 V, $f$ =1 MHz	
Output capacitance 7)	$C_{\rm oss}$	-	1500	1930	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =75 V, $f$ =1 MHz	
Reverse transfer capacitance <sup>7)</sup>	C <sub>rss</sub>	-	33	58	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =75 V, $f$ =1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	18.7	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1. 6 $\Omega$	
Rise time	t <sub>r</sub>	-	4.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	
Turn-off delay time	$t_{\sf d(off)}$	-	23.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1. 6 $\Omega$	
Fall time	t <sub>f</sub>	-	5.4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	

 $<sup>^{7)}</sup>$  Defined by design. Not subject to production test.

# OptiMOS™ 5 Power-Transistor, 150 V IPT039N15N5



Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note/Test Condition
raiailletei	Symbol	Min.	Тур.	Мах.	Oilit	Note/ Test Condition
Gate to source charge	$Q_{gs}$	-	31	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	22	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge <sup>9)</sup>	$Q_{ m gd}$	-	15.5	23	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	$Q_{sw}$	-	24	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>9)</sup>	$Q_{ m g}$	-	78	98	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	5.3	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Output charge <sup>9)</sup>	Q <sub>oss</sub>	-	219	291	nC	V <sub>DS</sub> =75 V, V <sub>GS</sub> =0 V

<sup>8)</sup> See "Gate charge waveforms" for parameter definition

### Table 7 Reverse diode

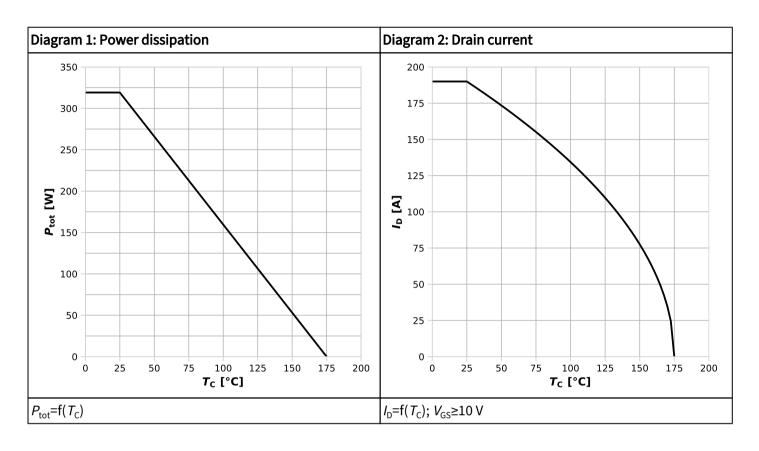
Parameter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Offic	Note/ Test Condition	
Diode continuous forward current	$I_{S}$	-	-	190	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	760	А	T <sub>C</sub> =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.81	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =50 A, $T_{\rm j}$ =25 °C	
Reverse recovery time <sup>10)</sup>	$t_{\rm rr}$	-	53.4	106.8	ns	$V_R$ =75 V, $I_F$ =50 A, d $i_F$ /d $t$ =100 A/ $\mu$ s	
Reverse recovery charge <sup>10)</sup>	$Q_{\rm rr}$	-	77.2	154.4	nC	$V_R$ =75 V, $I_F$ =50 A, d $i_F$ /d $t$ =100 A/ $\mu$ s	

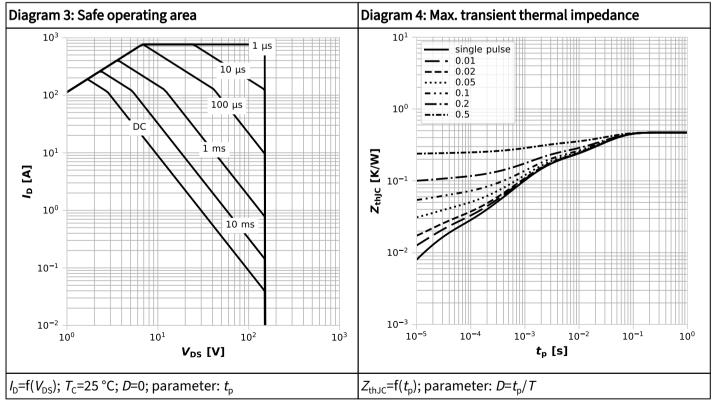
 $<sup>^{10)}\,\,\,</sup>$  Defined by design. Not subject to production test.

<sup>9)</sup> Defined by design. Not subject to production test.

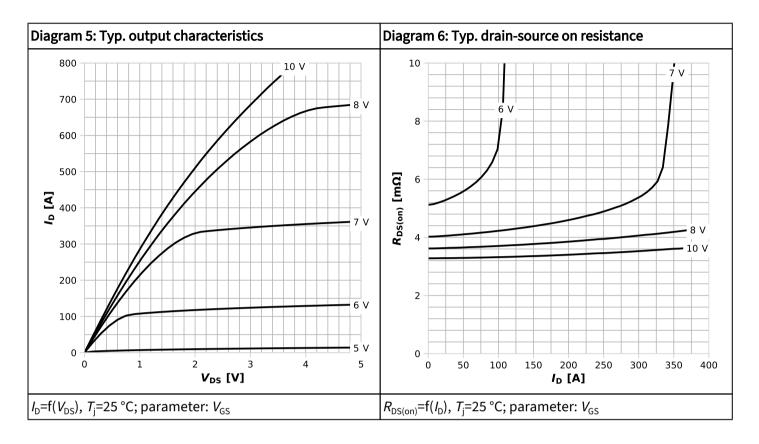


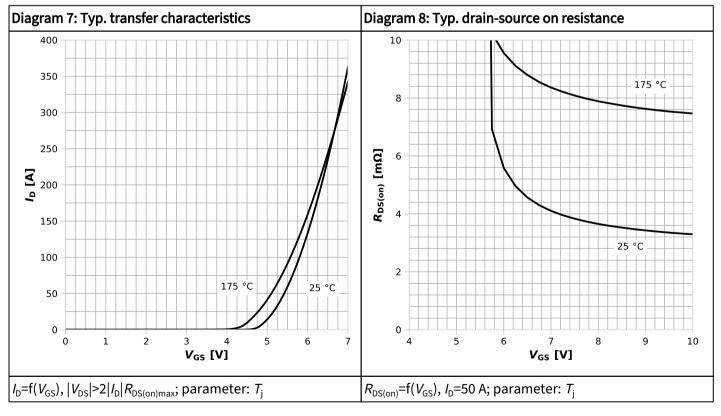
## 4 Electrical characteristics diagrams



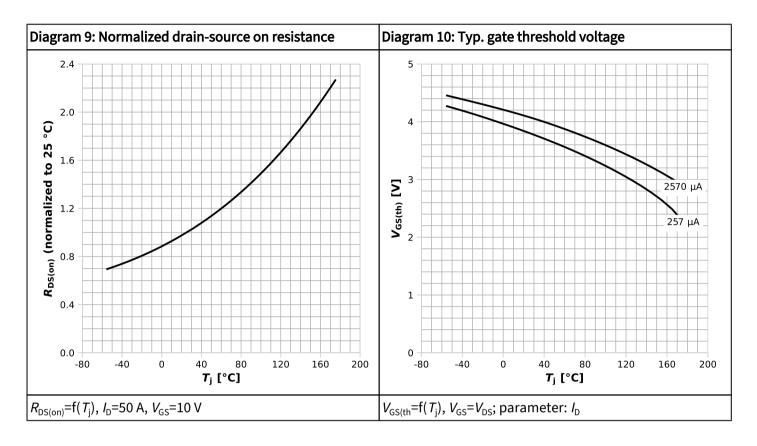


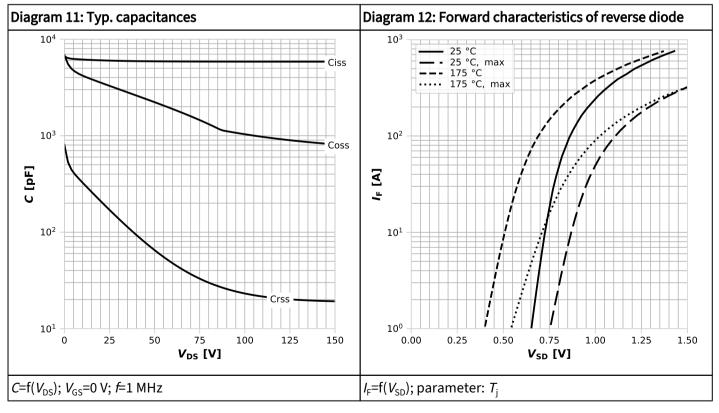




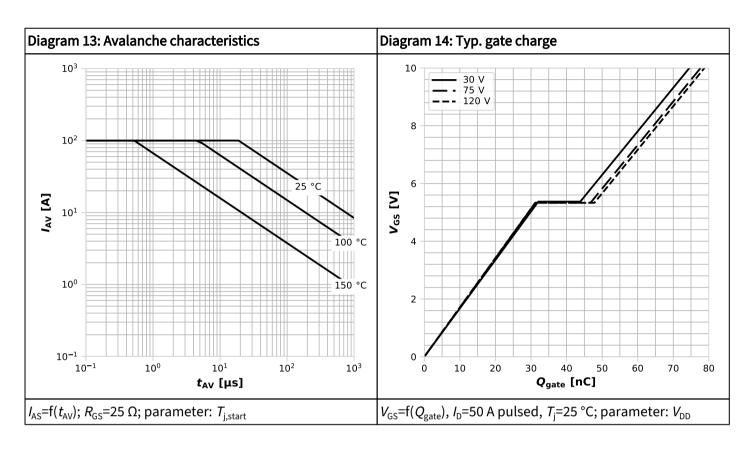


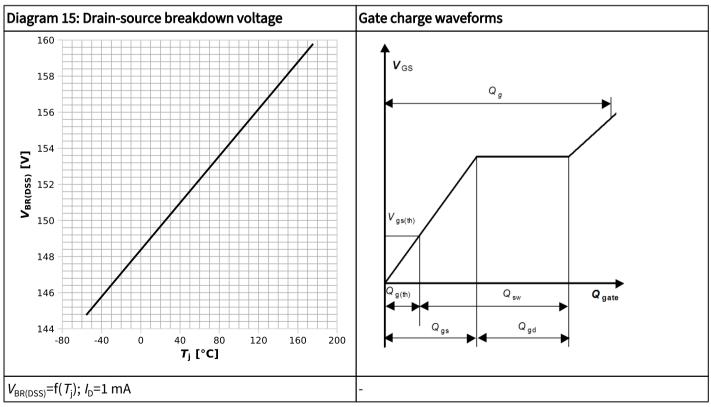






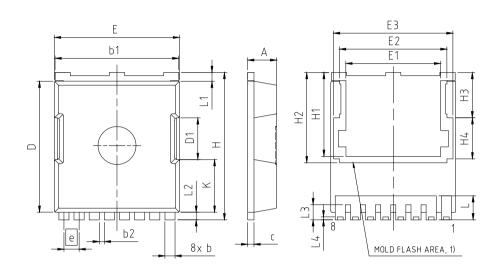




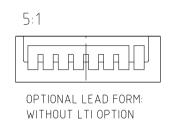




## 5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-HSOF-8-U01							
DIMENSIONS	MILLIM	IETERS						
DIMENSIONS	MIN.	MAX.						
Α	2.20	2.40						
b	0.70	0.90						
b1	9.70	9.90						
b2	0.42	0.50						
С	0.40	0.60						
D	10.28	10.58						
D1	3.30							
E	9.70	10.10						
E1	7.50							
E2	8.50							
E3	9.46							
е	1.20 (	(BSC)						
Н	11.48	11.88						
H1	6.55	6.95						
H2	7.	15						
Н3	3.	59						
H4	3.	26						
N	8							
K	4.18							
L	1.60	2.10						
L1	0.50	0.90						
L2	0.50	0.70						
L3	1.00	1.30						
L4	0.13	0.33						



1) PATIALLY COVERED WITH MOLD FLASH

Figure 1 Outline PG-HSOF-8, dimensions in mm



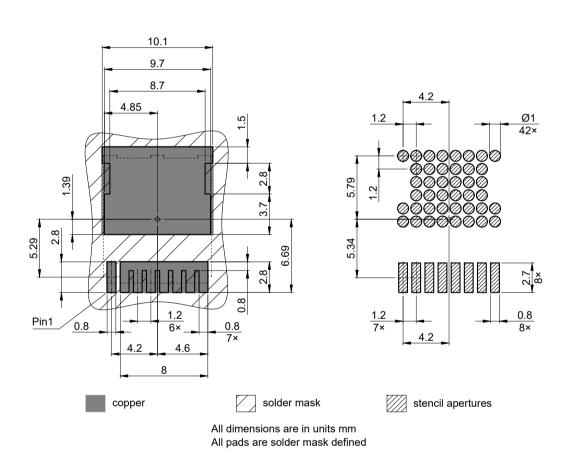


Figure 2 Outline PG-HSOF-8, dimensions in mm



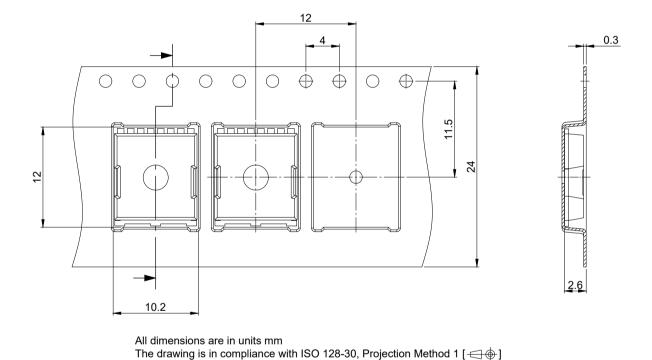


Figure 3 Outline PG-HSOF-8, dimensions in mm

## OptiMOS™ 5 Power-Transistor, 150 V IPT039N15N5



### **Revision History**

IPT039N15N5

### Revision 2024-06-11, Rev. 2.2

**Previous Revision** 

Revision	Date	Subjects (major changes since last revision)
2.0	2021-09-10	Release of final version
2.1	2023-03-08	Update Coss max
2.2	2024-06-11	Update Rg

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